

FIG. 1

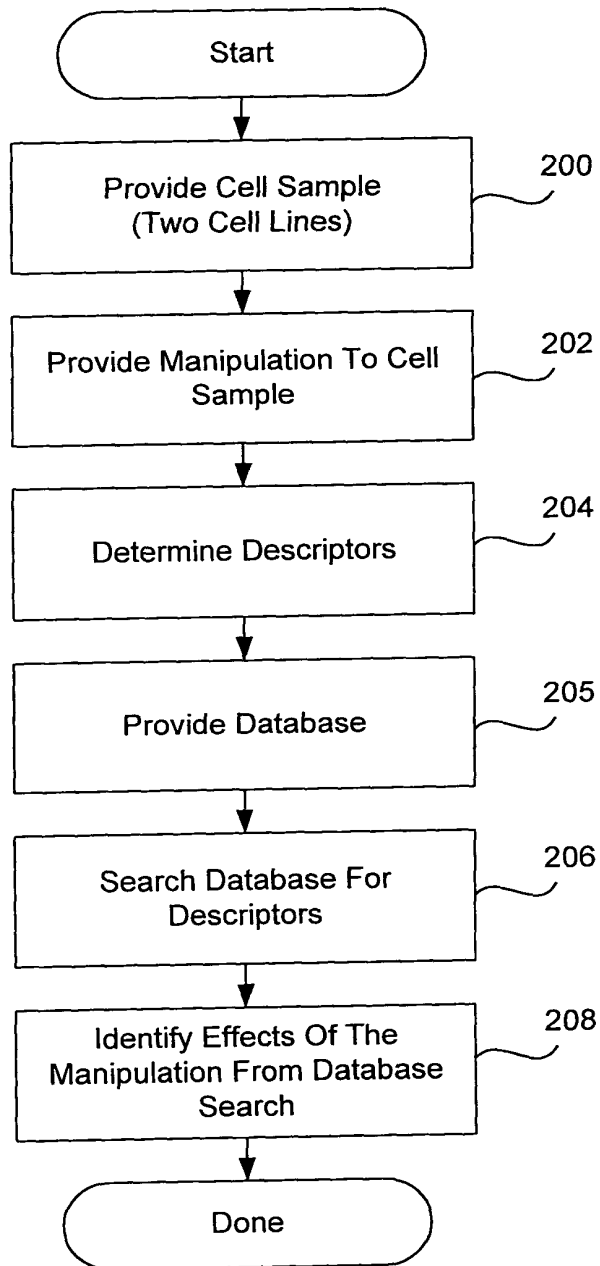
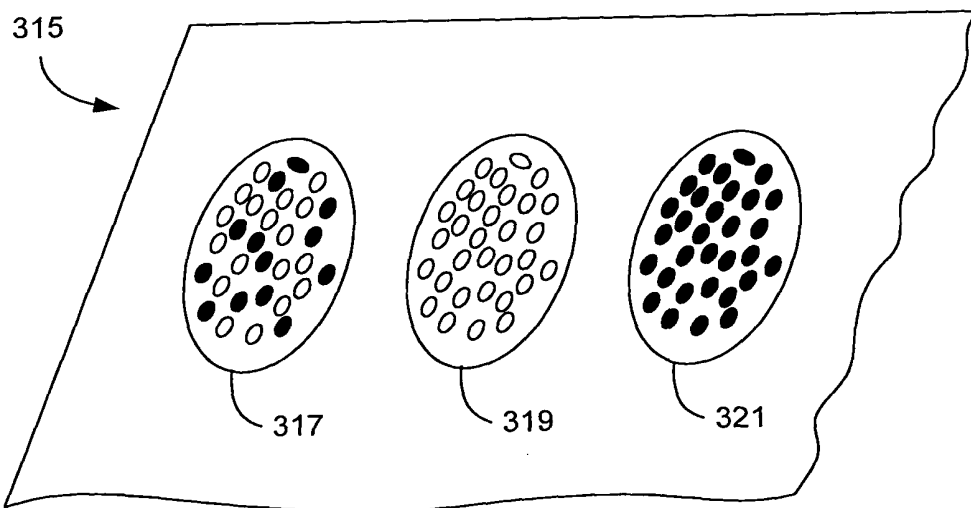
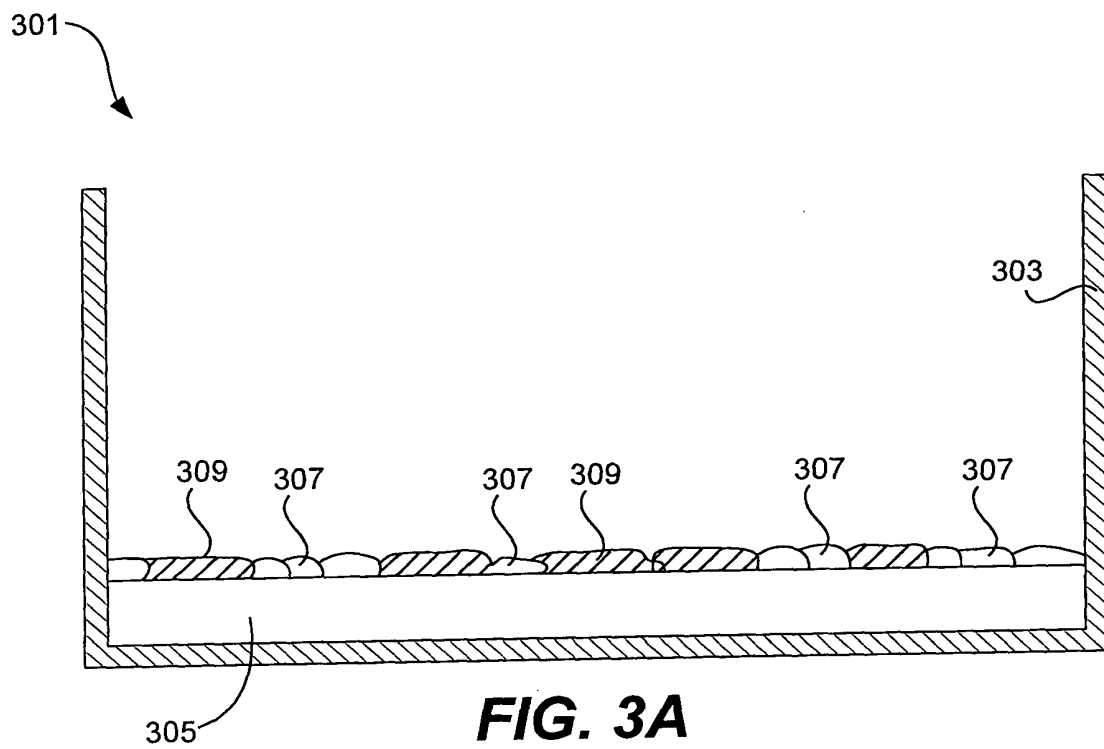


FIG. 2



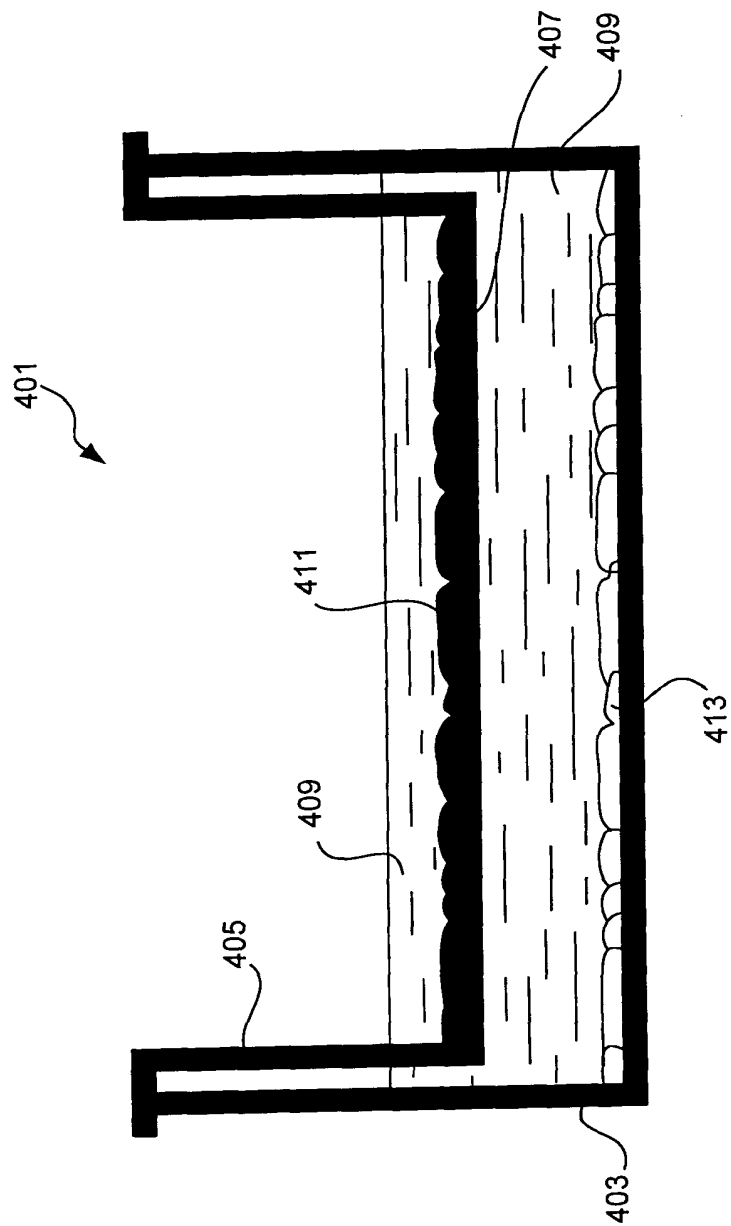


FIG. 4

FIG. 5A

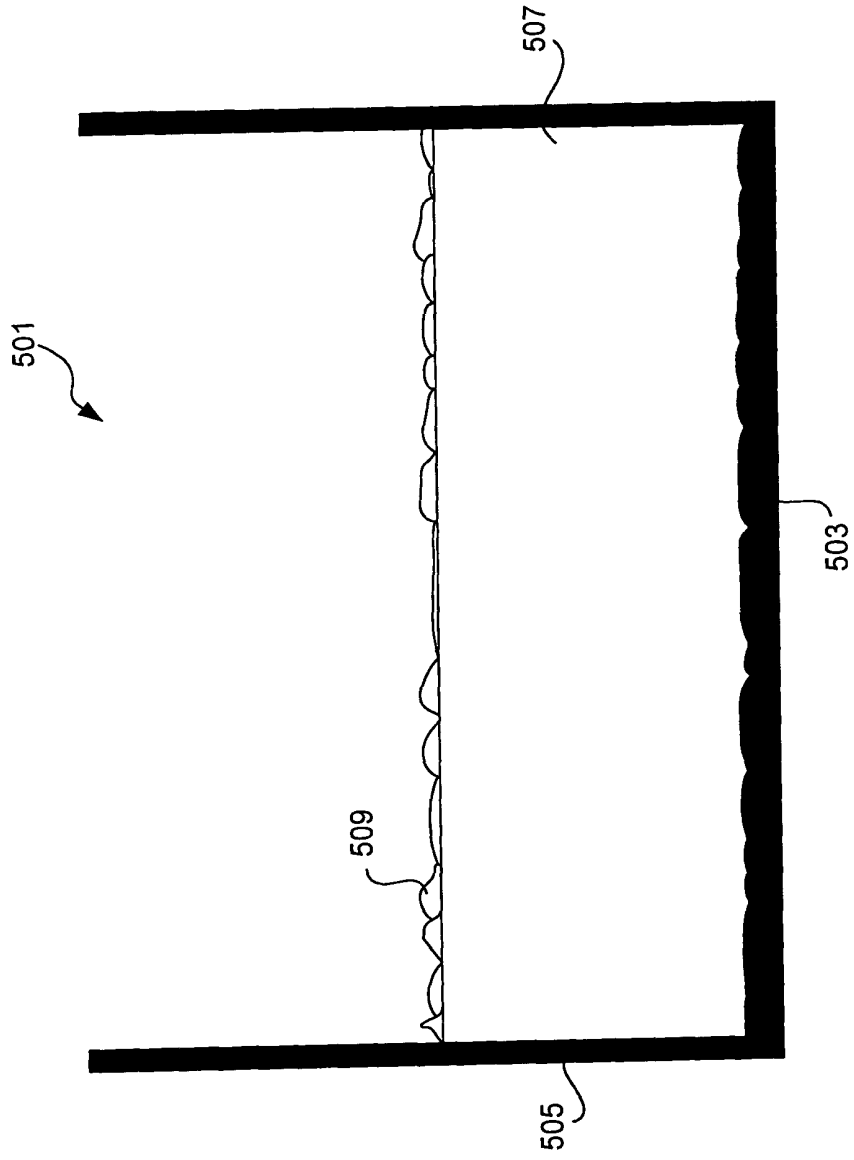


FIG. 5A

FIG. 5B is a cross-sectional view of the device 500, showing the device 500 in a cross-sectional view. The device 500 includes a substrate 501, a layer 503, a layer 505, a layer 507, and a layer 509. The layer 509 is a conductive layer, and the layer 507 is a dielectric layer. The layer 505 is a conductive layer, and the layer 503 is a dielectric layer. The device 500 is shown in a cross-sectional view, and the layers 501, 503, 505, 507, and 509 are labeled with arrows pointing to their respective layers.

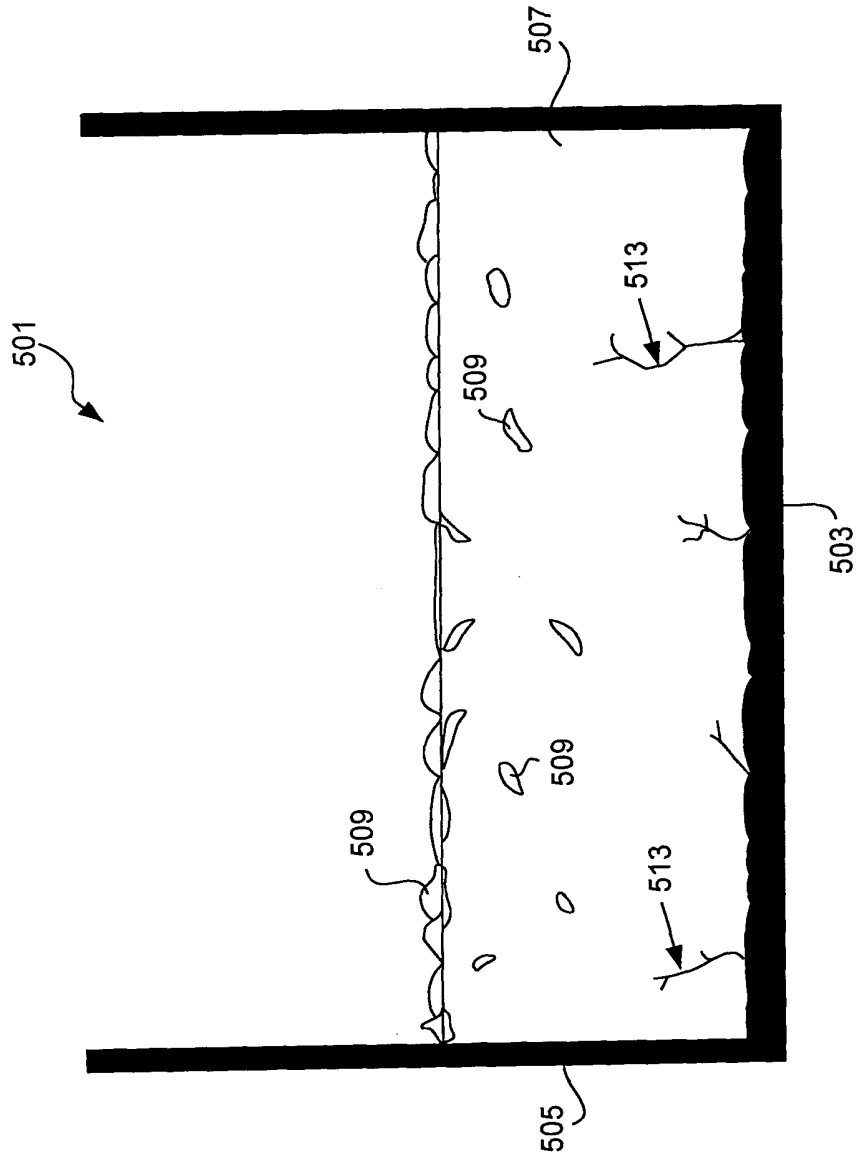


FIG. 5B

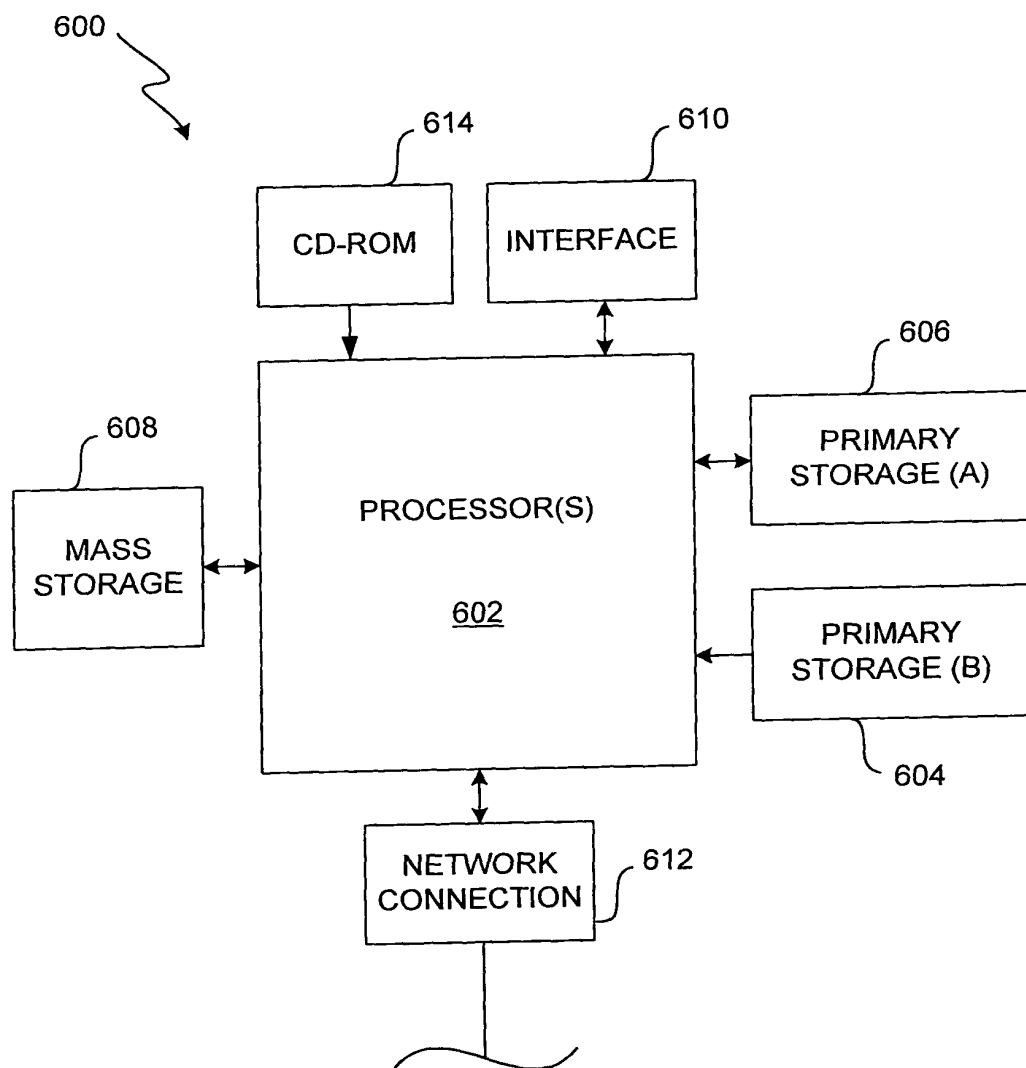


FIG. 6

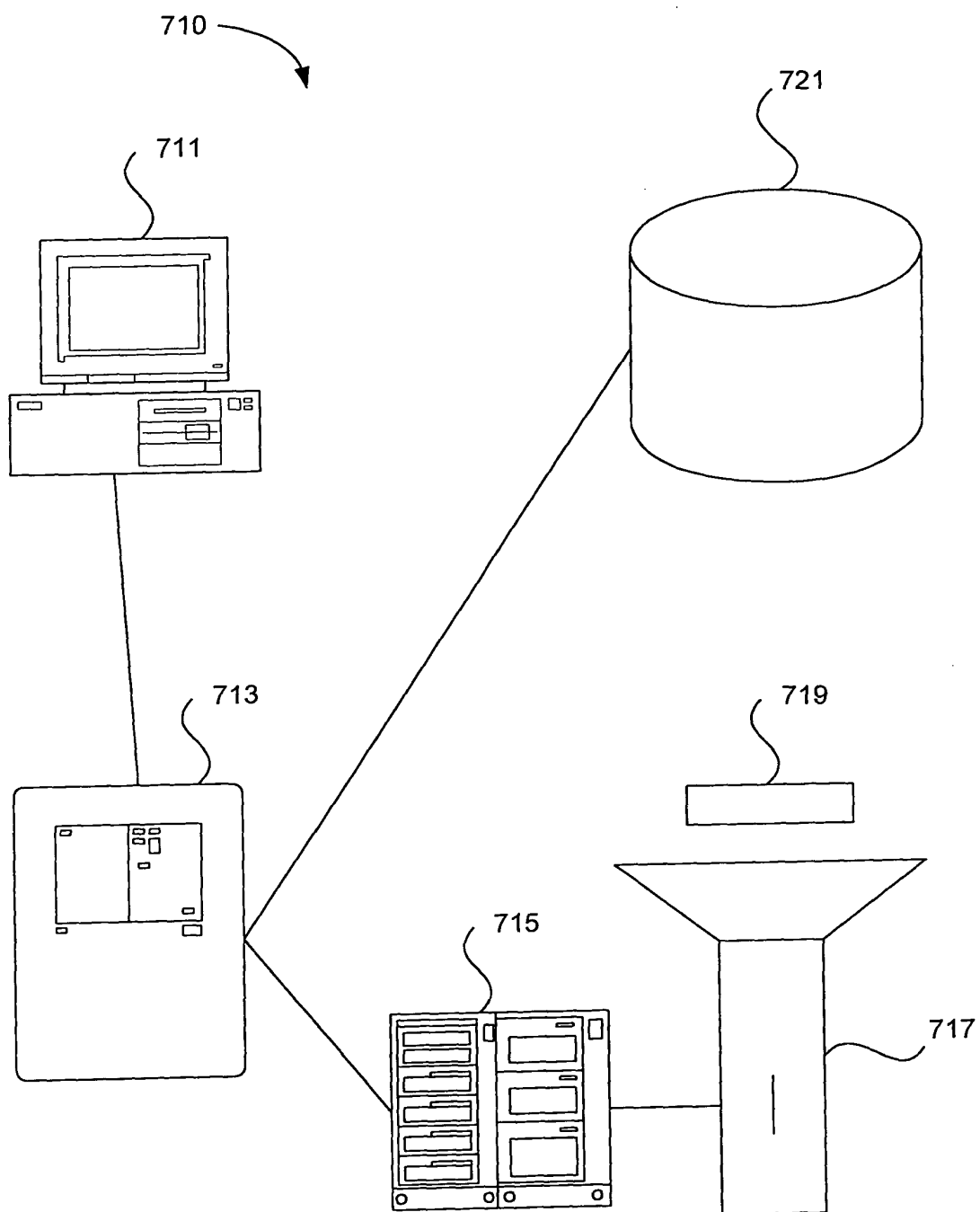


FIG. 7